

DATA SHEET

SKY66122-11: 863 to 928 MHz Front-End Module for Wi-SUN® Applications

Applications

- Range extenders
- Smart meters
- In-home appliances
- Smart thermostats

Features

- Output power: +30 dBm, Wi-SUN OFDM Option 1 MCS0
- Output power: +30 dBm, Wi-SUN OFDM Option 1 MCS3
- Output power: +25 dBm, Wi-SUN OFDM Option 3 MCS6
- Integrated LNA with 2.5 dB noise figure (typical)
- TX and RX power limiters for maximum ruggedness
- Integrated power detector
- Single-ended 50 Ω RF interface
- Supply voltage: 3.0 V to 5.0 V
- Sleep mode current: < 1 μA
- Small MCM (6 x 6 x 0.9 mm [nominal]) package (MSL3, 260 °C per JEDEC J-STD-020)

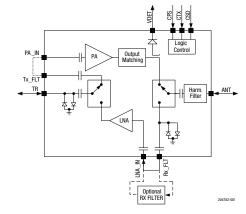


Figure 1. SKY66122-11 Block Diagram

Description

The SKY66122-11 is a high-performance, highly integrated RF front-end module (FEM) designed for high-power Industrial, Scientific, Medical (ISM) band, Wi-SUN®, and other IoT applications operating in the 863 to 928 MHz frequency range.

The SKY66122-11 is designed for ease of use and maximum flexibility with fully matched, 50 Ω RF input and output, and digital controls compatible with 1.6 to 3.6 V CMOS levels.

The RF blocks operate over a wide supply voltage range from 3.0 to 5.0 V that allows the SKY66122-11 to be used in battery powered applications over a wide spectrum of the battery discharge curve.

The SKY66122-11 is packaged in a 36-pin, 6 x 6 x 0.9 mm (nominal) Multi-Chip Module (MCM), which allows for a highly manufacturable, low-cost solution.

A functional block diagram of the SKY66122-11 is shown in Figure 1. The package and pinout are shown in Figure 2. Signal pin assignments and functional pin descriptions are provided in Table 1.



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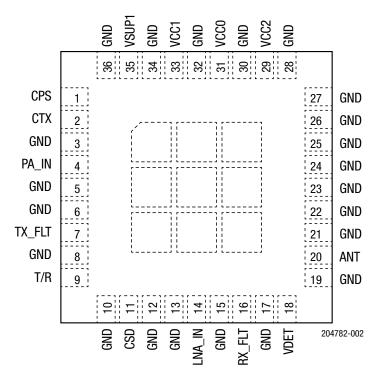


Figure 2. SKY66122-11 Pinout (Top View)

Table 1. SKY66122-11 Signal Descriptions

Pin	Name	Description	Pin	Name	Description
1	CPS	Path select control	19	GND	Ground
2	СТХ	Transmit/receive control	20	ANT	Antenna (integrated harmonic filtering)
3	GND	Ground	21	GND	Ground
4	PA_IN	Input to PA	22	GND	Ground
5	GND	Ground	23	GND	Ground
6	GND	Ground	24	GND	Ground
7	TX_FLT	Source for external TX filter	25	GND	Ground
8	GND	Ground	26	GND	Ground
9	T/R	Transmit and receive	27	GND	Ground
10	GND	Ground	28	GND	Ground
11	CSD	Mode control	29	VCC2	PA voltage supply
12	GND	Ground	30	GND	Ground
13	GND	Ground	31	VCC0	Decoupling capacitor
14	LNA_IN	LNA input	32	GND	Ground
15	GND	Ground	33	VCC1	PA voltage supply
16	RX_FLT	Source for external RX filter	34	GND	Ground
17	GND	Ground	35	VSUP1	General voltage supply
18	VDET	Voltage detector output	36	GND	Ground

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Technical Description

The SKY66122-11 consists of a complete transmit and receive (T/R) chain with T/R switches contained in the module. An SP2T switch selects between transmit and receive paths. The module has a shutdown mode to minimize power consumption.

Three digital input control pins (CSD, CTX, and CPS) are used to select between shutdown, transmit, and receive modes.

Electrical and Mechanical Specifications

The absolute maximum ratings of the SKY66122-11 are provided in Table 2. The DC electrical specifications, recommended operating conditions and other parameters are shown in the tables that follow.

Table 2. SKY66122-11 Absolute Maximum Ratings¹

Parameter	Symbol	Minimum	Maximum	Units
Supply voltage (no RF)	Vsupply	-0.3	+5.5	V
Control pin (CSD, CTX) voltages		-0.3	3.6	V
Operating temperature	Ta	-40	+85 ²	°C
Storage temperature	Tstg	-40	+125	°C
Transmit RF input power	Pin_tx_max		+16	dBm
Receive RF input power (ANT port)	Pin_rx_max		+15	dBm
Voltage standing wave ratio (ANT port)	VSWR		10:1	
Electrostatic discharge: Human Body Model (HBM), Class 1C	ESD		1000	V

^{1.} Exposure to maximum rating conditions for extended periods may reduce device reliability. Exceeding any of the limits listed here may result in permanent damage to the device.

ESD Handling: Industry-standard ESD handling precautions must be adhered to at all times to avoid damage to this device.

Table 3. SKY66122-11 Recommended Operating Conditions

Parameter	Symbol	Min	Тур	Max	Units
Supply voltage	Vcc	3.0	3.3	5.0	V
Operating temperature	Та	-40	+25	+85	°C

^{2.} Tested with 30% duty cycle at POUT = 30 dBm.

Table 4. SKY66122-11 DC Electrical Specifications¹

(VCC = +5.0 V, TA = +25 °C, as Measured on the SKY66122-11 Evaluation Board [De-Embedded to Device], Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
	ICC_TX30	POUT = +30 dBm		640		mA
Total supply current, transmit mode ²	ICC_TX28	POUT = +27.5 dBm	1	500		mA
	ICC_TX23	POUT = +23.5 dBm	1	325		mA
Total supply current, receive mode	lcc_rx			6.5		mA
Quiescent current	lcq_tx	No RF		55		mA
Sleep supply current	Icc_off	No RF		0.05	1.00	μΑ

^{1.} Performance is assured only under the conditions listed in this Table and is not invariant over the full operating or storage temperature ranges. Operation at elevated temperatures may reduce reliability of the device.

2. ICC_TX28 and ICC_TX23 are not production tested.

Table 5. SKY66122-11 Receive Mode Electrical Specifications¹ (VCC = +3.3 V or +5.0 V, TA = +25 °C, as Measured on the Evaluation Board [De-Embedded to Device], All Unused Ports Terminated with 50 Ω , Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
Frequency range	fo		863		928	MHz
Gain	RX_gain			16		dB
Noise figure	NF	7		2.6		dB
Third order input intercept point	IIP3			-1.5		dBm
1 dB input compression point	IP1dB	-		-10		dBm
Antenna port return loss	S11	Measured as test setup in Figure 15		10		dB
Turn-on time	ton	From 50% of CTX edge to 90% of final RF output power			3	us
Turn-off time	toff	From 50% of CTX edge to 10% of final RF output power			1	us
Max power RX_FLT	PMAX_RX_FLT			Refer to	Figure 3	1
Max power T/R RX mode	PMAX_TR_RX		Refer to Figure 4			

^{1.} Performance is assured only under the conditions listed in this Table and is not invariant over the full operating or storage temperature ranges. Operation at elevated temperatures may reduce reliability of the device.

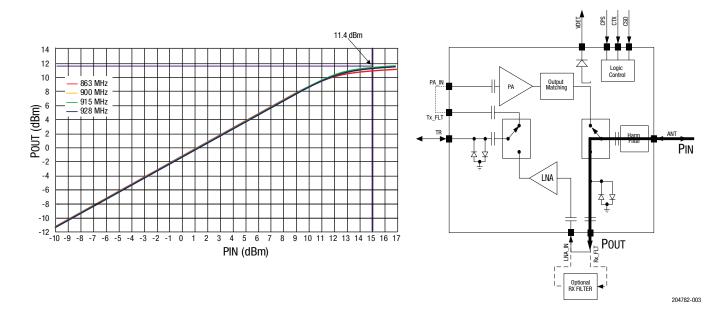


Figure 3. P_{IN} and P_{OUT} at RX_FLT Port

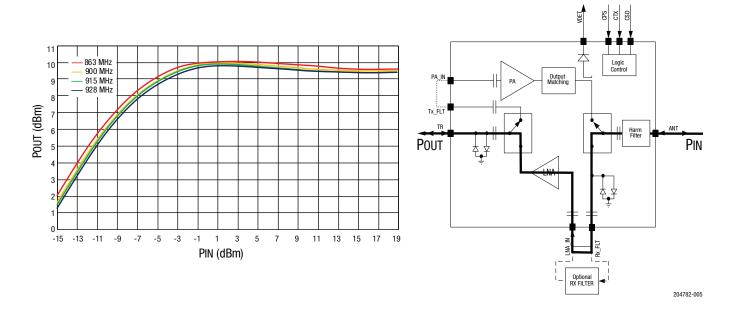


Figure 4. P_{IN} and P_{OUT} at T/R Port in Rx Mode

Table 6. SKY66122-11 Transmit Mode Electrical Specifications for 3.3 V Operation¹ (VCC = +3.3 V, TA = +25 °C, POUT = +27 dBm CW, as Measured on the Evaluation Board [De-Embedded to Device], All Unused Ports Terminated with 50 Ω, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
Frequency range	fo		863		928	MHz
RMS output power (ANT port) ²	Pout	Saturated (FSK mode) Option 1 MCSO, -10 dB EVM Option 1 MCS3, -10 dB EVM Option 3 MCS6, -19 dB EVM		+27 +26 +27 +22		dBm dBm dBm dBm
Small signal gain	S21	863 to 928 MHz		30	33	dB
Output return loss	S22	Measured as test setup in Figure 15		9		dB
2nd harmonic	2fo	Measured as test setup in Figure 15			-22	dBc
3rd to 10th harmonic	3fo to 10fo				-69	dBc
Power detection range	Vdet_range		+10		+27	dBm
Turn-on time	ton	From 50% of CTX edge to 90% of final RF output power		1		us
Turn-off time	toff	From 50% of CTX edge to 10% of final RF output power			1	us
Stability Stab		DC to 20 GHz, CW, POUT = +27 dBm into 50 ohms, load VSWR = 6:1	All non-harmonically related outputs < -42 dBm			-42 dBm
Ruggedness	RU	CW, POUT = +27 dBm into 50 ohms load, VSWR = 10:1	No permanent damage			
Max power TX_FLT	PMAX_TX_FLT		Refer to Figure 5			

^{1.} Performance is assured only under the conditions listed in this Table and is not invariant over the full operating or storage temperature ranges. Operation at elevated temperatures may reduce reliability of the device.

2. POUT maximum = 28 dBm.

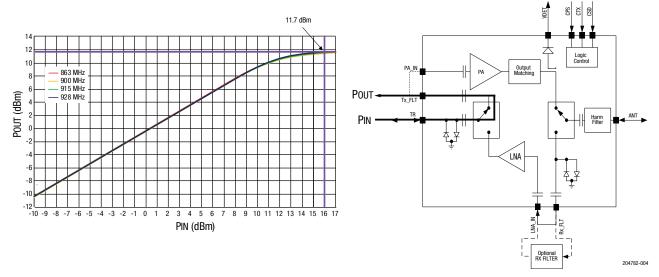


Figure 5. P_{IN} and P_{OUT} at TX_FLT Port

Table 7. SKY66122-11 Transmit Mode Electrical Specifications for 5.0 V Operation¹ (VCC = +5.0 V, TA = +25 °C, POUT = +30 dBm CW, as Measured on the Evaluation Board [De-Embedded to Device], All Unused Ports Terminated with 50 ohms, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
Frequency range	fo		863		928	MHz
RMS output power (ANT port)	Pout	Saturated (FSK mode) Option 1 MCSO, -10 dB EVM Option 1 MCS3, -10 dB EVM Option 3 MCS6, -19 dB EVM		+30 +30 +30 +25		dBm dBm dBm dBm
Small signal gain	S21	863 to 928 MHz		33		dB
Output return loss	S22	Measured as test setup in Figure 15		9		dB
2nd harmonic	2fo	Measured as test setup in Figure 15			-22	dBc
3rd to 10th harmonic	3fo to 10fo				-72	dBc
Power detection range	Vdet_range		+10		+30	dBm
Turn-on time	ton	From 50% of CTX edge to 90% of final RF output power		1		us
Turn-off time	toff	From 50% of CTX edge to 10% of final RF output power			1	us
Stability Stab		DC to 20 GHz, CW, POUT = +30 dBm into 50 ohms, load VSWR = 6:1	All non-harmonically related outputs < -42 dBm			< -42 dBm
Ruggedness	RU	CW, POUT = +30 dBm into 50 ohms load, VSWR = 10:1	No permanent damage			
Max power TX_FLT	PMAX_TX_FLT		Refer to Figure 5			

^{1.} Performance is assured only under the conditions listed in this Table and is not invariant over the full operating or storage temperature ranges. Operation at elevated temperatures may reduce reliability of the device.

Table 8. SKY66122-11 Transmit Mode Electrical Specifications, Control Logic Characteristics¹ (TA = +25 °C, as Measured on the SKY66122-11 Evaluation Board, Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Тур	Max	Units
Control voltage High Low	Vih Vil		1.6 0		3.6 0.3	V V
Input current High Low	lih lil				1 1	μΑ μΑ

^{1.} Performance is assured only under the conditions listed in this Table and is not invariant over the full operating or storage temperature ranges. Operation at elevated temperatures may reduce reliability of the device.

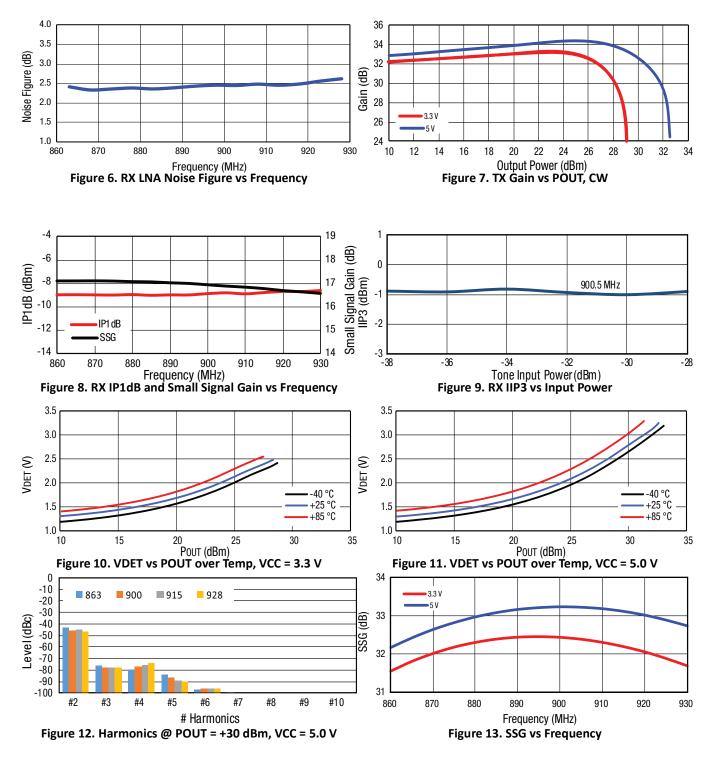
Table 9. SKY66122-11 Mode Control Logic¹

Mode	Description	CSD	CTX (FEA)	CPS (FEB)	Notes
0	Shutdown/sleep	1	0	0	
1	RX LNA	1	0	1	
2	TX	1	1	1	
3	Unsupported	1	1	0	
4	Shutdown/sleep	0	0	0	Only condition where 1 µA of leakage current is guaranteed
5	Shutdown/sleep	0	0	1	
6	Shutdown/sleep	0	1	1	
7	Shutdown/sleep	0	1	0	

^{1.} Make sure each control logic has the proper pull-up and pull-down in the application circuit.

Typical Performance Characteristics

(Vcc0 = Vcc1 = 3.3 V, f = 915 MHz, TA = +25 °C, Unless Otherwise Noted)



Evaluation Board Description

The SKY66122-11 Evaluation Board is used to test the performance of the SKY66122-11 front-end module. The Evaluation Board is shown in Figure 14. An Evaluation Board schematic diagram is provided in Figure 15. Layer detail information is provided in Figure 16. The Evaluation Board Bill of Materials is listed in Table 10.

PCB Recommendations

Top layer: Plan to add the footprint for a shield case over the RF section.

Bottom layer: Lay out as much as possible for minimum traces on the bottom. Having a solid ground plane under the shield case will complete the shielding.

Avoid using thermal relief pads for ground connections of components and the shield case. Always place vias close to each shunt connection.

Spread ground vias equally in a manner that stitches the grounds together.

Metal Layer 1 = RF traces (microstripes or coplanar) + control lines. Core thickness between top RF layer and ground plane is critical.

Metal Layer 2 = Solid ground plane. No trace routings. Metal Layer 3 = Control lines + VCC traces (no VCC plane) Metal Layer 4 = Solid ground plane under the shield case area.

Pour copper on each layer connected to the ground plane. Use VCC traces in a star distribution pattern.



Figure 14. SKY66122-11 Evaluation Board

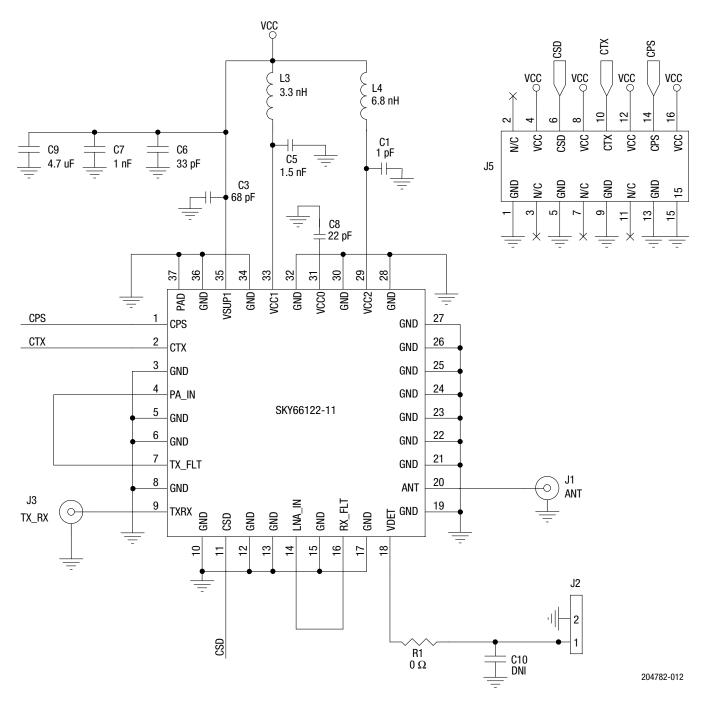
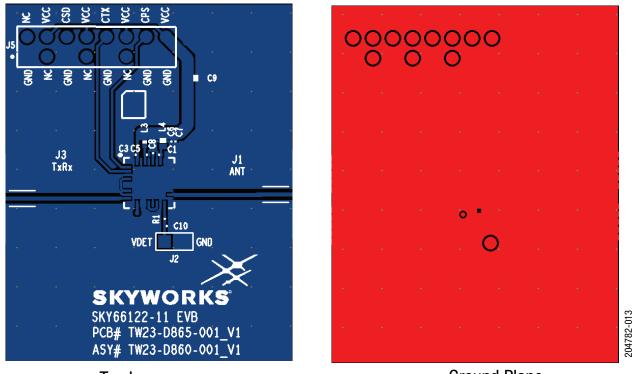


Figure 15. SKY66122-11 Evaluation Board Schematic



Top Layer Ground Plane
Figure 16. SKY66122-11 Evaluation Board Layer Details

Table 10. SKY66122-11 Evaluation Board Bill of Materials

Component	Value	Manufacturer	Mfr Part Number	Size	Description
C5	1.5 nF	Murata	GRM033R71C152JA01	0201	Multilayer ceramic
C7	1 nF	Murata	GRM033R71C102JD01	0201	Multilayer ceramic
C1	1 pF	Murata	GRM0335C1E1R0BD01	0201	Multilayer ceramic
L3	3.3 nH	Coilcraft	0402CS-3N3XJL	0402	
C9	4.7 uF	Murata	GRM188R60J475KE19	0603	Multilayer ceramic
L4	6.8 nH	Coilcraft	0603CS-6N8XJL	0603	
J2	1 x 2	Samtec			Header pin
J5	8 x 2	Samtec			Header pin
C8	22 pF	Murata	GRM0335C1E220JD01	0201	Multilayer ceramic
C6	33 pF	Murata	GRM0335C1E330JD01	0201	Multilayer ceramic
C3	68 pF	Murata	GRM0335C1E680JD01	0201	Multilayer ceramic
C10	DNI				
R1	0 Ω			0201	Any supplier
U1	SKY66122-11	Skyworks Solutions Inc.	SKY66122-11	MCM600X600	
PCB1	TW23-D865-001_V1	Skyworks Solutions Inc.	TW23-D865-001_V1		PCB
J1, J3	SMA	Johnson Components	142-0701-851	End launch	SMA end launch straight jack receptacle - tab contact

Package Dimensions

Typical part markings are shown in Figure 17. The PCB layout footprint is shown in Figure 18. Package dimensions for the SKY66122-11 are shown in Figure 19, and tape and reel dimensions are provided in Figure 20.

Package and Handling Information

Since the device package is sensitive to moisture absorption, it is baked and vacuum packed before shipping. Instructions on the shipping container label regarding exposure to moisture after the container seal is broken must be followed. Otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly.

The SKY66122-11 is rated to Moisture Sensitivity Level 3 (MSL3) at 260 °C. It can be used for lead or lead-free soldering. For additional information, refer to the Skyworks Application Note, PCB Design & SMT Assembly/Rework Guidelines for MCM-L Packages, document number 101752.

Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. Production quantities of this product are shipped in a standard tape and reel format.

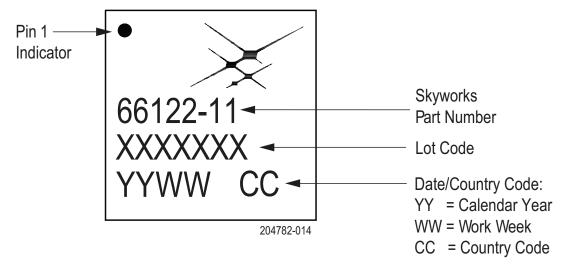
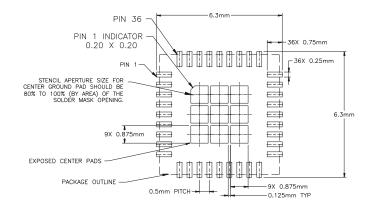
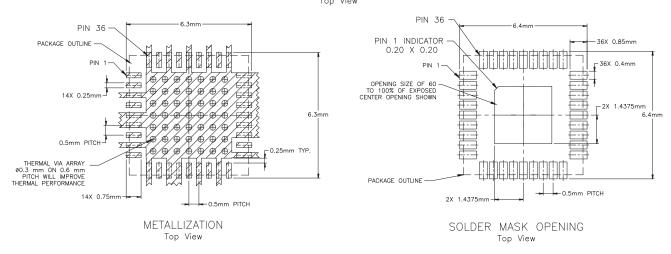


Figure 17. SKY66122-11 Typical Part Marking



STENCIL APERTURE Top View



NOTE: THERMAL VIAS SHOULD BE RESIN FILLED AND CAPPED IN ACCORDANCE WITH IPC-4761 TYPE VII VIAS. 30-35UM Cu THICKNESS IS RECOMMENDED.

204782-016

Figure 18. SKY66122-11 PCB Layout Footprint

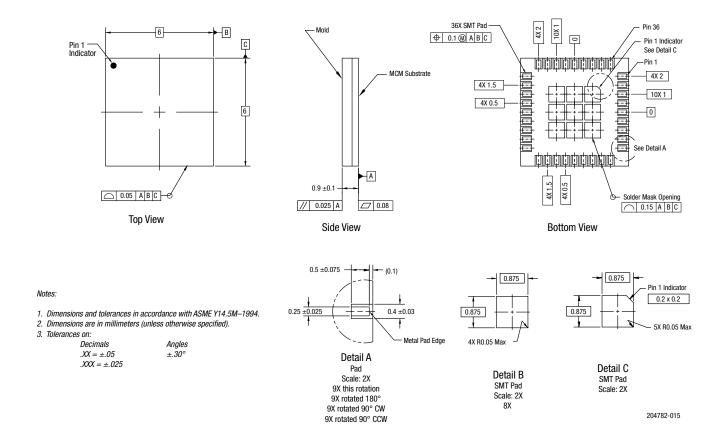
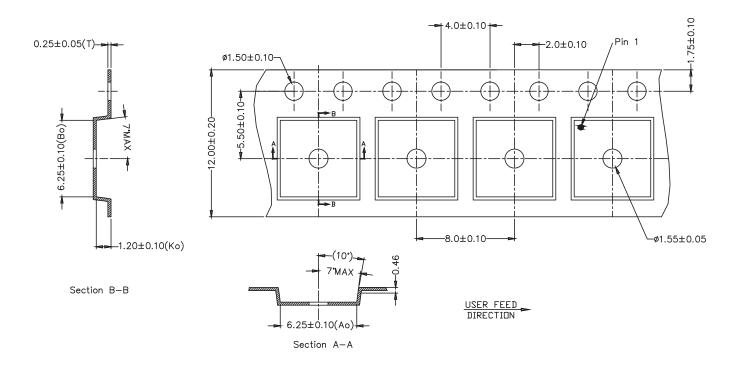


Figure 19. SKY66122-11 Package Dimensions



NOTES:

10 SPROCKET HOLE PITCH CUMULATIVE TOLERANCE : ± 0.20 mm Ao & Bo MEASURED ON PLANE 0.30mm ABOVE THE BOTTOM OF THE POCKET. ALL DIMENSIONS ARE IN MILLIMETERS.

204782-020

Figure 20. SKY66122-11 Tape and Reel Dimensions

Ordering Information

Part Number	Part Description	Evaluation Board Part Number
SKY66122-11	863 to 928 MHz Front-End Module for Wi-SUN® Applications	SKY66122-11EK1

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